

**Terminal Disclaimer To Obviate A Double  
Patenting Rejection Over A Prior Patent**

Docket No.  
NEC 01207 DIV2

Application Of: USAMI

Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
10/695,159	October 28, 2003	Lee, Hsien Ming	27667	2823	7174

Invention: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING SAME

Owner of Record: NEC ELECTRONICS CORPORATION (a subsidiary of NEC CORPORATION)

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The above-identified owner of record of a 100 percent interest in the instant application hereby disclaims, except as provided below, the terminal part of the statutory term of any patent granted on the instant application, which would extend beyond the expiration date of the full statutory term defined in 35 U.S.C. 154 to 156 and 173, as presently shortened by any terminal disclaimer, of prior Patent No. 6,514,852. The owner hereby agrees that any patent so granted on the instant application shall be enforceable only for and during such period that it and the prior patent are commonly owned. This agreement runs with any patent granted on the instant application and is binding upon the grantee, its successors and/or assigns.

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

2. ☒ The undersigned is an attorney of record.

01/31/2005 MBIZUNES 00000155 10695159

  
Signature

Dated: January 24, 2005

Norman P. Soloway  
Typed or Printed Name

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- ☒ Terminal disclaimer fee under 37 C.F.R. 1.20(d) included.  
☒ PTO suggested wording for terminal disclaimer was unchanged.  
☐ Certification under 37 C.F.R. 3.73(b) is required if terminal disclaimer is signed by the assignee.



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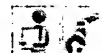
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